

# Declaration and Power of Attorney for Patent Application

特許出願宣言書及び委任状

## Japanese Language Declaration

日本語宣言書

私は、以下に記名された発明者として、ここに下記の通り宣言する。

私の住所、郵便の宛先及び国籍は、私の氏名の後に記載された通りである。

下記の名称の発明について、特許請求範囲に記載され、且つ特許が求められている発明主題に関して、私は、最初、最先且つ唯一の発明者である（唯一の氏名が記載されている場合）が亦或いは最初、最先且つ共同発明者である（複数の氏名が記載されている場合）と信じている。

□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □

---

□ 上記発明の明細書はここに添付されているが、下記の欄がX印でチェックされている場合は、この限りでない：

\_\_\_\_月 \_\_\_\_日に出願され、

この出願の米国出願番号またはPCT国際出願番号は、

\_\_\_\_\_ であり、且つ

\_\_\_\_月 \_\_\_\_日に補正された出願（該当する場合）

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## ELECTRICALLY CONDUCTING CURABLE RESIN COMPOSITION AND CURED PRODUCT THEREOF

---

the specification of which is attached hereto unless the following box is checked:

was filed on \_\_\_\_\_  
as United States Application Number or  
PCT International Application Number

\_\_\_\_\_ and was amended on  
\_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

私は、連邦規則法典第37編1.56に定義されている特許性について重要な情報を開示する義務があることを認める。

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

# Japanese Language Declaration

(日本語宣言書)

私は、ここに、下記に記載した外国での特許出願または発明者証の出願、あるいは米国以外の少なくとも一ヵ国を指定している米国法典第35編365条(a)項によるPCT国際出願について、同第119条(a)-(d)項又は第365条(b)項に基づいて優先権を主張するとともに、優先権を主張する本出願の出願日よりも前の出願日を有する外国での特許出願または発明者証の出願、あるいはPCT国際出願については、いかなる出願も、下記の枠内をチェックすることにより示した。

## Prior Foreign Applications

外国での先行出願

P2000-274868

(Number)  
(番号)

JAPAN

(Country)  
(国名)

(Country)  
(国名)

(Country)  
(国名)

(Country)  
(国名)

(Filing Date)  
(出願日)

(Filing Date)  
(出願日)

(Filing Date)  
(出願日)

(Filing Date)  
(出願日)

(Application No.)  
(出願番号)

(Filing Date)  
(出願日)

(Application No.)  
(出願番号)

(Filing Date)  
(出願日)

I hereby claim foreign priority under Title 35, United States Code, Section 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Priority Not Claimed  
優先権主張なし



September 11, 2000

(Day/Month/Year Filed)  
(出願日/月/年)



(Day/Month/Year Filed)  
(出願日/月/年)



(Day/Month/Year Filed)  
(出願日/月/年)

I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below.

60/258,873

(Application No.)  
(出願番号)

January 2, 2001

(Filing Date)  
(出願日)

I hereby claim the benefit of Title 35, United States Code Section 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose any material information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

(Status: Patented, Pending, Abandoned)  
(現況: 特許許可済、係属中、放棄済)

(Status: Patented, Pending, Abandoned)  
(現況: 特許許可済、係属中、放棄済)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

# Japanese Language Declaration

(日本語宣言書)

委任状：私は、本出願を審査する手続きを行い、且つ米国特許商標庁との全ての業務を遂行するために、記名された発明者として、下記の弁護士及び/または弁理士を任命する。(氏名及び登録番号を記載すること)

POWER OF ATTORNEY: As a named Inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number)

John H. Mion, Reg. No. 18,879; Robert J. Seas, Jr., Reg. No. 21,092; Darryl Mexic, Reg. No. 23,063; Robert V. Sloan, Reg. No. 22,775; Peter D. Olexy, Reg. No. 24,513; J. Frank Osha, Reg. No. 24,625; Louis Gubinsky, Reg. No. 24,835; Neil B. Siegel, Reg. No. 25,200; David J. Cushing, Reg. No. 28,703; John R. Inge, Reg. No. 26,916; Joseph J. Ruch, Jr., Reg. No. 26,577; Sheldon I. Landsman, Reg. No. 25,430; Richard C. Turner, Reg. No. 29,710; Howard L. Bernstein, Reg. No. 25,665; Alan J. Kasper, Reg. No. 25,426; Kenneth J. Burchfiel, Reg. No. 31,333; Gordon Kit, Reg. No. 30,764; Susan J. Mack, Reg. No. 30,951; Frank L. Bernstein, Reg. No. 31,484; Mark Bojand, Reg. No. 32,197; William H. Mandir, Reg. No. 32,156; Brian W. Hannon, Reg. No. 32,778; Abraham J. Rosner, Reg. No. 33,276; Bruce E. Kramer, Reg. No. 33,725; Paul F. Neils, Reg. No. 33,102; Brett S. Sylvester, Reg. No. 32,765; Robert M. Masters, Reg. No. 35,603; George F. Lehnik, Reg. No. 36,359; John T. Callahan, Reg. No. 32,607; Steven M. Gruskin, Reg. No. 36,818; Peter A. McKenna, Reg. No. 38,551 and Edward F. Kenehan, Jr., Reg. 28,962

書類送付先：

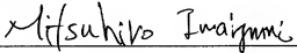
Send Correspondence to:

SUGHRUE MION, PLLC  
2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3213

普通電話連絡先：(名称及び電話番号)

Direct Telephone Calls to: (name and telephone number)

(202)293-7060

Full name of sole or first inventor 唯一又は第一発明者名	Tadashi IINO	
Inventor's signature 発明者の署名		
Residence 住所	Kanagawa, Japan	
Citizenship 国籍	Japanese	
Post office address 郵便の宛先	C/O KAWASAKI RESEARCH LABORATORY, CENTRAL RESEARCH LABORATORY, SHOWA DENKO K.K., 3-2 Chidori-cho, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-0865 JAPAN	
Full name of second joint inventor, if any 第二共同発明者名(該当する場合)	Mitsuhiro IMAIZUMI	
Second Inventor's signature 第二発明者名の署名		
Residence 住所	Kanagawa, Japan	
Citizenship 国籍	Japanese	
Post office address 郵便の宛先	C/O KAWASAKI RESEARCH LABORATORY, CENTRAL RESEARCH LABORATORY, SHOWA DENKO K.K., 3-2 Chidori-cho, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-0865 JAPAN	

(第三以降の共同発明者についても同様に記載し、署名をすること。)  
(Supply similar information and signature for third and subsequent joint inventors.)

# Japanese Language Declaration

(日本語宣言書)

Full name of third joint inventor, if any 第三共同発明者名(該当する場合)	Ryutaro FUJIHIRA
Third Inventor's signature 第三発明者の署名	Ryutaro Fujihira
Residence 住所	Kanagawa, Japan
Citizenship 国籍	Japanese
Post office address 郵便の宛先	C/O KAWASAKI RESEARCH LABORATORY, CENTRAL RESEARCH LABORATORY, SHOWA DENKO K.K., 3-2 Chidori-cho, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-0865 JAPAN
Full name of fourth joint inventor, if any 第四共同発明者名(該当する場合)	Makoto ENDO
Fourth Inventor's signature 第四発明者の署名	Makoto Endo
Residence 住所	Kanagawa, Japan
Citizenship 国籍	Japanese
Post office address 郵便の宛先	C/O TECHNICAL CENTER, EC-SHOWA DENKO K.K., 3-2 Chidori-cho, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-0865 JAPAN
Full name of fifth joint inventor, if any 第五共同発明者名(該当する場合)	Fumio MATSUI
Fifth Inventor's signature 第五発明者の署名	Fumio Matsui
Residence 住所	Tokyo, Japan
Citizenship 国籍	Japanese
Post office address 郵便の宛先	C/O SHOWA HIGHPOLYMER CO., LTD., 3-20 Kandanishiki-cho, Chiyoda-ku, Tokyo 101-0054 JAPAN
Full name of sixth joint inventor, if any 第六共同発明者名(該当する場合)	Yoshitaka HATANO
Sixth Inventor's signature 第六発明者の署名	Yoshitaka Hatano
Residence 住所	Tokyo, Japan
Citizenship 国籍	Japanese
Post office address 郵便の宛先	C/O SHOWA HIGHPOLYMER CO., LTD., 3-20 Kandanishiki-cho, Chiyoda-ku, Tokyo 101-0054 JAPAN